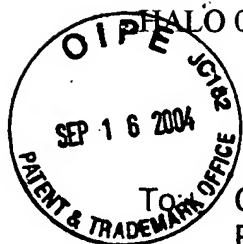


IFW



HALO 01-014B

September 9, 2004

To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Fr: George O. Saile, Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/697,925 10/30/03

Seiki Ogura

Twin NAND Device Structure, Array
Operations and Fabrication Method

Grp. Art Unit:

Preliminary Amendment

Dear Sir:

Please amend the above-identified application for patent as follows:

The Commissioner is hereby authorized to charge payment of any additional fee involved with added Claims and the like to Deposit Account No. 19-0033.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on September 14, 2004.

Name Stephen B. Ackerman, Reg. No. 37761

Signature 

Date September 14, 2004

Please amend the above-identified application as follows:

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Drawings begin on page 8 of this paper and include both an attached replacement sheet and an annotated sheet showing changes.

Remarks/Arguments begin on page 9 of this paper.

An **Appendix** including amended drawing figures is attached following page 10 of this paper.